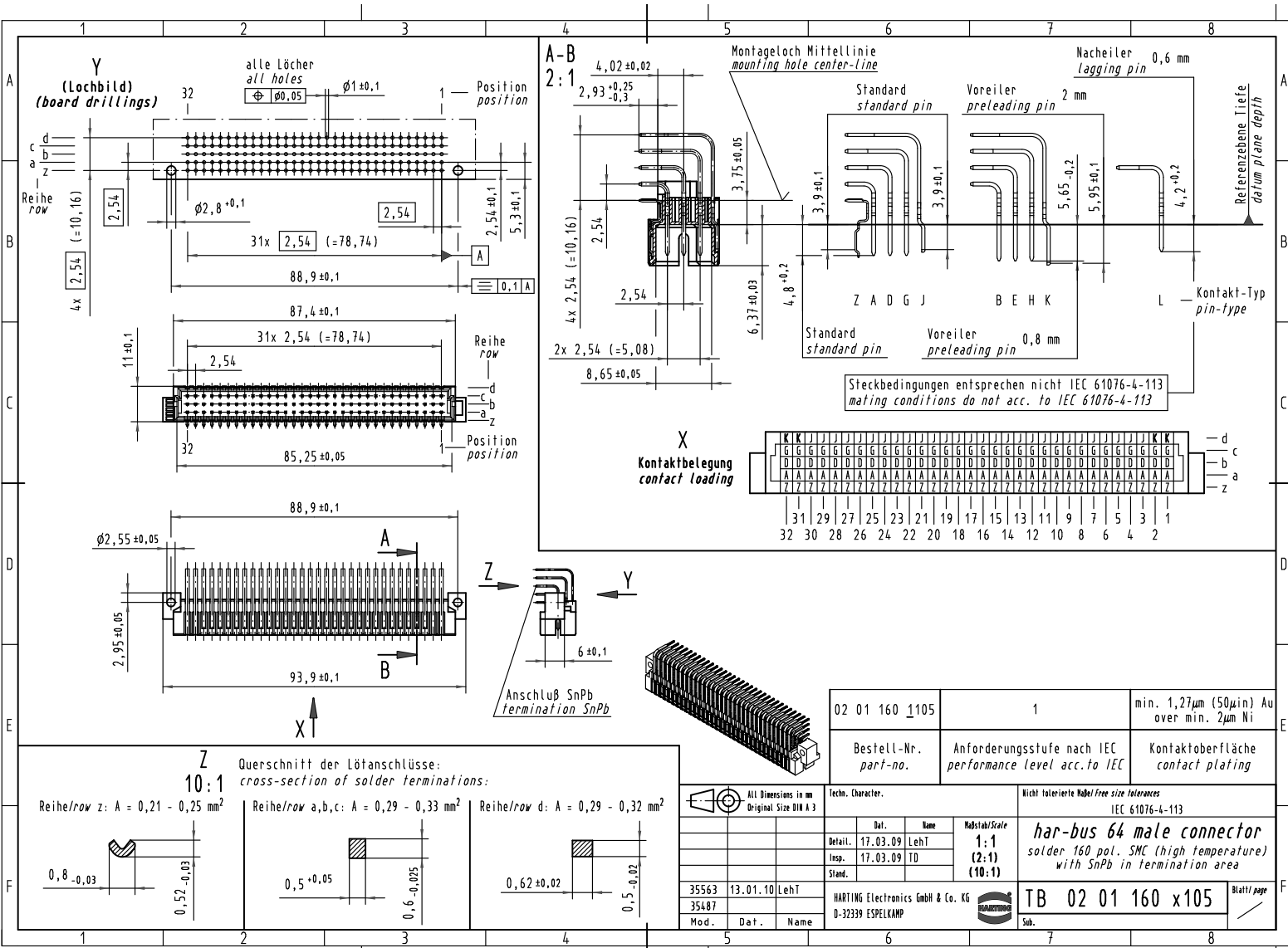
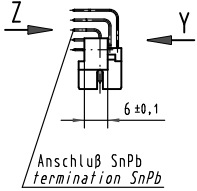
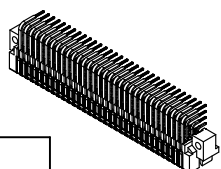


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02 01 160 1105	1	min. 1,27µm (50µin) Au over min. 2µm Ni
Bestell-Nr. part-no.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

Techn. Character. Dat. Name Maßstab/Scale Detail: 17.03.09 LeHT 1:1 Insp. 17.03.09 TD (2:1) Stand. (10:1)		Nicht tolerierte Maß/Free size tolerances IEC 61076-4-113 har-bus 64 male connector solder 160 pol. SMC (high temperature) with SnPb in termination area	
35563	13.01.10	LeHT	TB 02 01 160 x105 Blatt/page Sub. 7
35487			
HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP			



Z Querschnitt der Lötanschlüsse:
cross-section of solder terminations:

Reihe/row z: A = 0,21 - 0,25 mm² Reihe/row a,b,c: A = 0,29 - 0,33 mm² Reihe/row d: A = 0,29 - 0,32 mm²

10:1

<p>0,8^{+0,03} 0,52^{-0,03}</p>	<p>0,5^{+0,05} 0,6^{-0,025}</p>	<p>0,62^{+0,02} 0,5^{-0,02}</p>
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